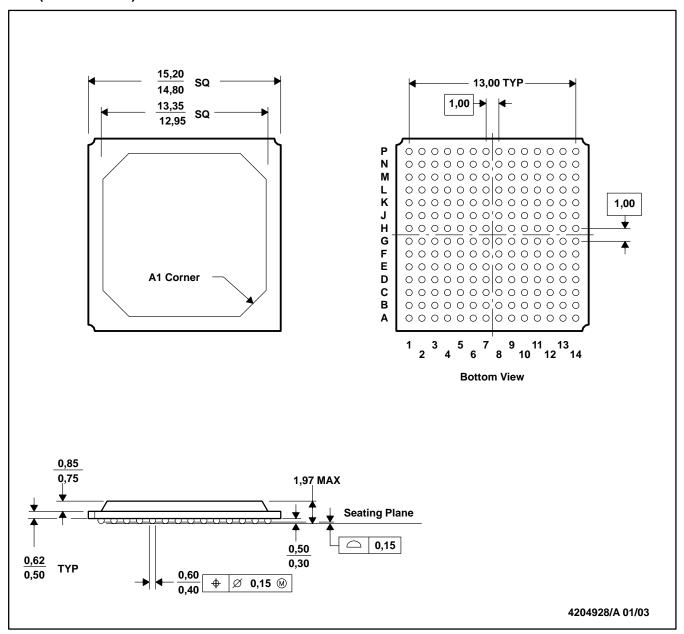
ZEA (S-PBGA-N196)

PLASTIC BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-151
- D. This package is Lead-free.

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